

ZXMN3A04K

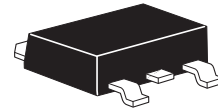
30V N-CANNEL ENHANCEMENT MODE MOSFET IN DPAK

SUMMARY

$V_{(BR)DSS}=30V$: $R_{DS(on)}=0.02\Omega$; $I_D=18.4A$

DESCRIPTION

This new generation of Trench MOSFETs from Zetex utilizes a unique structure that combines the benefits of low on-resistance with fast switching speed. This makes them ideal for high efficiency, low voltage power management applications.



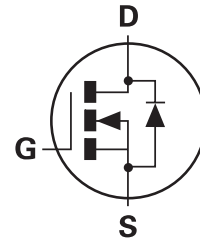
DPAK

FEATURES

- Low on-resistance
- Fast switching speed
- Low threshold
- Low gate drive
- DPAK (TO252) package

APPLICATIONS

- DC-DC converters
- Power management functions
- Disconnect switches
- Motor control



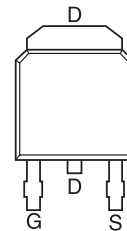
ORDERING INFORMATION

| DEVICE | REEL SIZE | TAPE WIDTH | QUANTITY PER REEL |
|-------------|-----------|------------|-------------------|
| ZXMN3A04KTC | 13" | 16mm | 2500 units |

DEVICE MARKING

- ZXMN
3A04K

PINOUT



TOP VIEW

ZXMN3A04K

ABSOLUTE MAXIMUM RATINGS

| PARAMETER | SYMBOL | LIMIT | UNIT |
|---|----------------|-------------|----------------|
| Drain-source voltage | V_{DSS} | 30 | V |
| Gate-source voltage | V_{GS} | ± 20 | V |
| Continuous drain current @ $V_{GS}=10V$; $T_A=25^\circ C$ ^(b) | I_D | 18.4 | A |
| @ $V_{GS}=10V$; $T_A=70^\circ C$ ^(b) | | 14.7 | A |
| @ $V_{GS}=10V$; $T_A=25^\circ C$ ^(a) | | 12.0 | A |
| Pulsed drain current ^(c) | I_{DM} | 66 | A |
| Continuous source current (body diode) ^(b) | I_S | 11.5 | A |
| Pulsed source current (body diode) ^(c) | I_{SM} | 66 | A |
| Power dissipation at $T_A = 25^\circ C$ ^(a) | P_D | 4.3 | W |
| Linear derating factor | | 34.4 | mW/ $^\circ C$ |
| Power dissipation at $T_A = 25^\circ C$ ^(b) | P_D | 10.1 | W |
| Linear derating factor | | 80.8 | mW/ $^\circ C$ |
| Power dissipation at $T_A = 25^\circ C$ ^(d) | P_D | 2.15 | W |
| Linear derating factor | | 17.2 | mW/ $^\circ C$ |
| Operating and storage temperature range | T_j, T_{stg} | -55 to +150 | $^\circ C$ |

THERMAL RESISTANCE

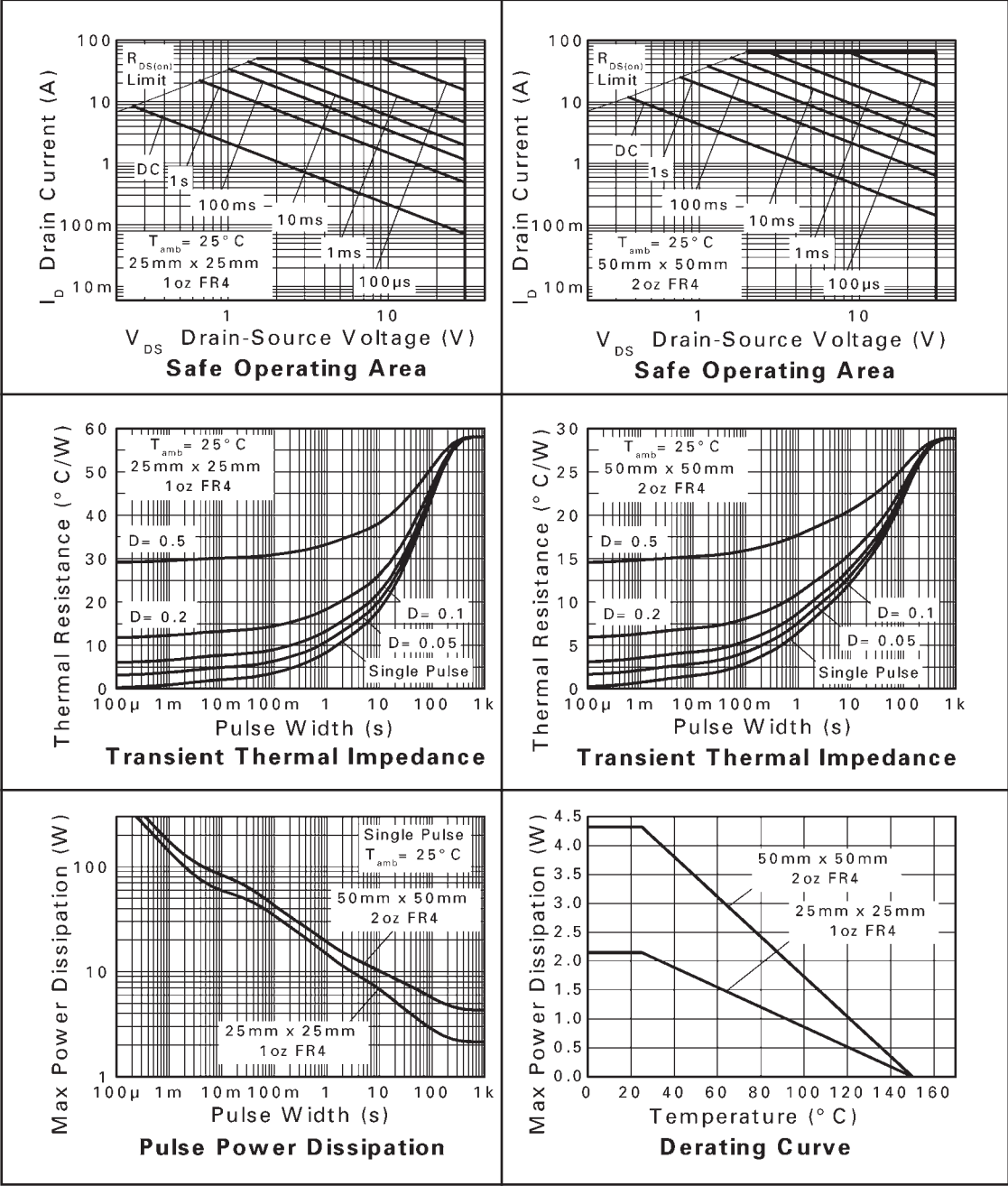
| PARAMETER | SYMBOL | VALUE | UNIT |
|------------------------------------|-----------------|-------|--------------|
| Junction to ambient ^(a) | $R_{\theta JA}$ | 29 | $^\circ C/W$ |
| Junction to ambient ^(b) | $R_{\theta JA}$ | 12.3 | $^\circ C/W$ |
| Junction to ambient ^(d) | $R_{\theta JA}$ | 58 | $^\circ C/W$ |

NOTES

- (a) For a device surface mounted on 50mm x 50mm x 1.6mm FR4 PCB with high coverage of single sided 2oz copper, in still air conditions.
 (b) For a device surface mounted on FR4 PCB measured at ≤ 10 sec.
 (c) Repetitive rating 50mm x 50mm x 1.6mm FR4 PCB, D=0.02 pulse width=300 μs - pulse width limited by maximum junction temperature.
 (d) For a device surface mounted on 50mm x 50mm x 1.6mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions.

ZXMN3A04K

TYPICAL CHARACTERISTICS



ZXMN3A04K

ELECTRICAL CHARACTERISTICS (at $T_{amb} = 25^{\circ}\text{C}$ unless otherwise stated)

| PARAMETER | SYMBOL | MIN. | TYP. | MAX. | UNIT | CONDITIONS |
|--|---------------|------|------|------|---------------|--|
| STATIC | | | | | | |
| Drain-source breakdown voltage | $V_{(BR)DSS}$ | 30 | | | V | $I_D = 250\mu\text{A}$, $V_{GS} = 0\text{V}$ |
| Zero gate voltage drain current | I_{DSS} | | | 0.5 | μA | $V_{DS} = 30\text{V}$, $V_{GS} = 0\text{V}$ |
| Gate-body leakage | I_{GSS} | | | 100 | nA | $V_{GS} = \pm 20\text{V}$, $V_{DS} = 0\text{V}$ |
| Gate-source threshold voltage | $V_{GS(th)}$ | 1.0 | | | V | $I_D = 250\text{mA}$, $V_{DS} = V_{GS}$ |
| Static drain-source on-state resistance ⁽¹⁾ | $R_{DS(on)}$ | | | 0.02 | Ω | $V_{GS} = 10\text{V}$, $I_D = 12\text{A}$ |
| | | | | 0.03 | Ω | $V_{GS} = 4.5\text{V}$, $I_D = 9.8\text{A}$ |
| Forward transconductance ⁽¹⁾ ⁽³⁾ | g_{fs} | | 22.1 | | S | $V_{DS} = 15\text{V}$, $I_D = 12.6\text{A}$ |
| DYNAMIC ⁽³⁾ | | | | | | |
| Input capacitance | C_{iss} | | 1890 | | pF | $V_{DS} = 15\text{V}$, $V_{GS} = 0\text{V}$ $f = 1\text{MHz}$ |
| Output capacitance | C_{oss} | | 349 | | pF | |
| Reverse transfer capacitance | C_{rss} | | 218 | | pF | |
| SWITCHING ⁽²⁾ ⁽³⁾ | | | | | | |
| Turn-on-delay time | $t_{d(on)}$ | | 5.2 | | ns | $V_{DD} = 15\text{V}$, $I_D = 1\text{A}$ $R_G = 6.0\Omega$, $V_{GS} = 10\text{V}$ |
| Rise time | t_r | | 6.1 | | ns | |
| Turn-off delay time | $t_{d(off)}$ | | 38.1 | | ns | |
| Fall time | t_f | | 20.2 | | ns | |
| Total gate charge | Q_g | | 19.9 | | nC | $V_{DS} = 15\text{V}$, $V_{GS} = 5\text{V}$ $I_D = 6.5\text{A}$ |
| Total gate charge | Q_g | | 36.8 | | nC | $V_{DS} = 15\text{V}$, $V_{GS} = 10\text{V}$ $I_D = 6.5\text{A}$ |
| Gate-source charge | Q_{gs} | | 5.8 | | nC | |
| Gate drain charge | Q_{gd} | | 7.1 | | nC | |
| SOURCE-DRAIN DIODE | | | | | | |
| Diode forward voltage (1) | V_{SD} | | 0.85 | 0.95 | V | $T_J = 25^{\circ}\text{C}$, $I_S = 6.8\text{A}$, $V_{GS} = 0\text{V}$ |
| Reverse recovery time (3) | t_{rr} | | 18.4 | | ns | $T_J = 25^{\circ}\text{C}$, $I_S = 2.3\text{A}$, |
| Reverse recovery charge (3) | Q_{rr} | | 11 | | nC | $di/dt = 100\text{A}/\mu\text{s}$ |

NOTES

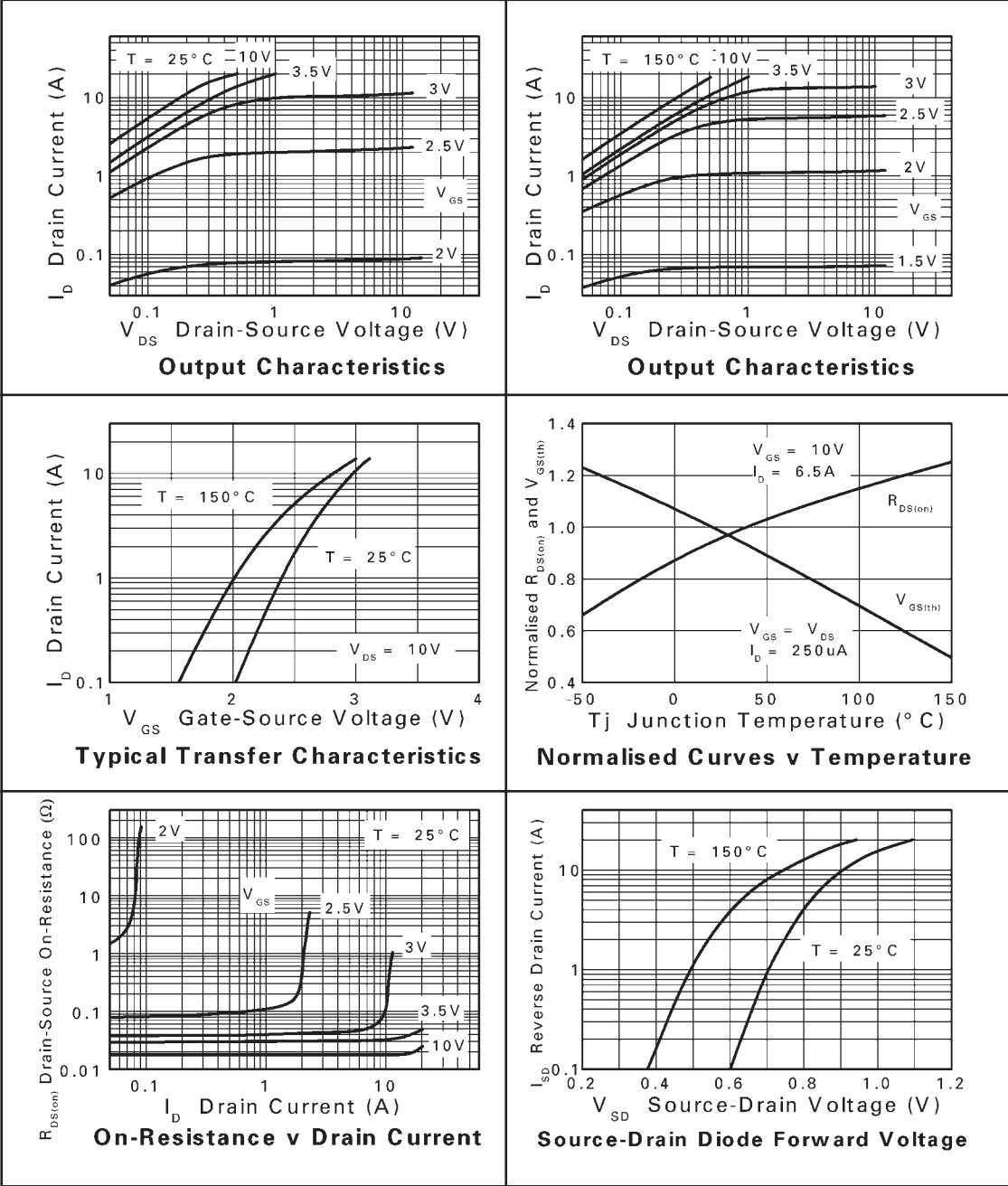
(1) Measured under pulsed conditions. Pulse width $\leq 300\mu\text{s}$; duty cycle $\leq 2\%$.

(2) Switching characteristics are independent of operating junction temperature.

(3) For design aid only, not subject to production testing.

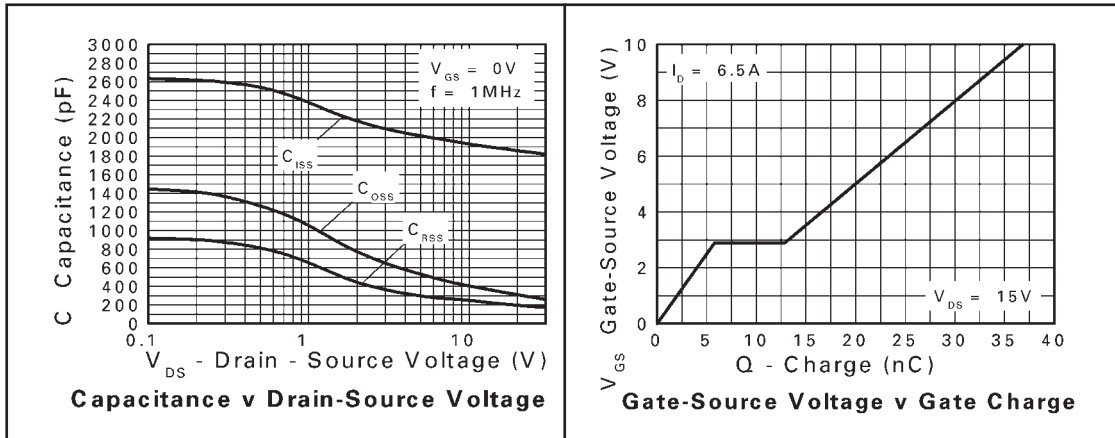
ZXMN3A04K

TYPICAL CHARACTERISTICS



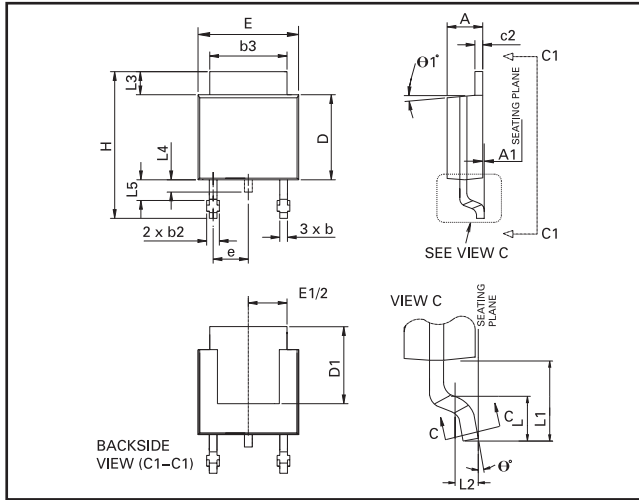
ZXMN3A04K

TYPICAL CHARACTERISTICS



ZXMN3A04K

PACKAGE OUTLINE



Controlling dimensions are in millimeters. Approximate conversions are given in inches

PACKAGE DIMENSIONS

| DIM | Millimeters | | Inches | | DIM | Millimeters | | Inches | |
|-----|-------------|-------|--------|-------|----------|-------------|-------|-----------|-------|
| | Min | Max | Min | Max | | Min | Max | Min | Max |
| A | 2.18 | 2.38 | 0.086 | 0.094 | e | 2.30 BSC | | 0.090 BSC | |
| A1 | — | 0.127 | — | 0.005 | H | 9.40 | 10.41 | 0.370 | 0.410 |
| b | 0.635 | 0.89 | 0.025 | 0.035 | L | 1.40 | 1.78 | 0.055 | 0.070 |
| b2 | 0.762 | 1.114 | 0.030 | 0.045 | L1 | 2.74 REF | | 0.108 REF | |
| b3 | 5.20 | 5.46 | 0.205 | 0.215 | L2 | 0.051 BSC | | 0.020 BSC | |
| c | 0.457 | 0.609 | 0.018 | 0.024 | L3 | 0.89 | 1.27 | 0.035 | 0.050 |
| c2 | 0.457 | 0.584 | 0.018 | 0.023 | L4 | 0.635 | 1.01 | 0.025 | 0.040 |
| D | 5.97 | 6.22 | 0.235 | 0.245 | L5 | 1.14 | 1.52 | 0.045 | 0.060 |
| D1 | 5.20 | — | 0.205 | — | theta 1° | 0° | 10° | 0° | 10° |
| E | 6.35 | 6.73 | 0.250 | 0.265 | theta° | 0° | 15° | 0° | 15° |
| E1 | 4.32 | — | 0.170 | — | — | — | — | — | — |

© Zetex plc 2004

| Europe | Americas | Asia Pacific | Corporate Headquarters |
|---|---|--|---|
| Zetex GmbH Streitfeldstraße 19 D-81673 München Germany | Zetex Inc 700 Veterans Memorial Hwy Hauppauge, NY 11788 USA | Zetex (Asia) Ltd 3701-04 Metroplaza Tower 1 Hing Fong Road, Kwai Fong Hong Kong | Zetex plc Fields New Road, Chadderton Oldham, OL9 8NP United Kingdom |
| Telephone: (49) 89 45 49 49 0 Fax: (49) 89 45 49 49 49 europe.sales@zetex.com | Telephone: (1) 631 360 2222 Fax: (1) 631 360 8222 usa.sales@zetex.com | Telephone: (852) 26100 611 Fax: (852) 24250 494 asia.sales@zetex.com | Telephone (44) 161 622 4444 Fax: (44) 161 622 4446 hq@zetex.com |

These offices are supported by agents and distributors in major countries world-wide.

This publication is issued to provide outline information only which (unless agreed by the Company in writing) may not be used, applied or reproduced for any purpose or form part of any order or contract or be regarded as a representation relating to the products or services concerned. The Company reserves the right to alter without notice the specification, design, price or conditions of supply of any product or service.

For the latest product information, log on to www.zetex.com

ISSUE 1 - FEBRUARY 2004



Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

Телефон: 8 (812) 309 58 32 (многоканальный)

Факс: 8 (812) 320-02-42

Электронная почта: org@eplast1.ru

Адрес: 198099, г. Санкт-Петербург, ул. Калинина, дом 2, корпус 4, литера А.